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STL40C30H3LL

N-channel 30 V, 0.019 Ω typ., 10 A, P-channel 30 V, 0.024 Ω typ.,8 A STripFETTM VI Power MOSFET in a PowerFLAT 5x6 d. i. package

Datasheet - production data

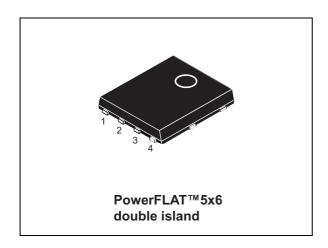
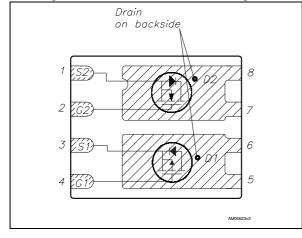


Figure 1. Internal schematic diagram



Features

Order code	Channel	V _{DS}	R _{DS(on)} max	I _D
STL40C30H3LL	N	30 V	0.021 Ω @ 10 V	10 A
STL40C30H3LL	Р	30 V	0.03 Ω @ 10 V	8 A

- R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

Applications

· Switching applications

Description

This device is a complementary N-channel and P-channel Power MOSFET developed using STripFET™ V (P-channel) and STripFET™ VI DeepGATE™ (N-channel) technologies. The resulting device exhibits low on-state resistance and an FOM among the lowest in its voltage class.

Table 1. Device summary

Order code	Marking	Packages	Packaging
STL40C30H3LL	40C30H3L	PowerFLAT 5x6 double island	Tape and reel

Note: For the P-channel MOSFET actual polarity of voltages and current has to be reversed

Contents STL40C30H3LL

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STL40C30H3LL Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Cumbal	Parameter	Val	ue	Umit
Symbol	Parameter	N-channel	P-channel	Unit
V _{DS}	Drain-source voltage (v _{gs} = 0)	30)	V
V_{GS}	Gate- source voltage	±2	.0	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25°C 40 30		Α	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100°C single operating	25	18.75	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 25°C single operating	10	8	Α
I _D ⁽²⁾	Drain current (continuous) at T _{pcb} = 100°C single operating	6.5	5	Α
I _{DM} (2)(3)	Drain current (pulsed)	40	32	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25°C 60)	W
P _{TOT} ⁽²⁾	Total dissipation at T _{pcb} = 25°C 4		W	
T _{stg}	Storage temperature -55 to 150		°C	
T _j	Operating junction temperature	150		°C

^{1.} The value is rated according to R_{thj-c}

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-c}	Thermal resistance junction-case	2.08	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb single operation	32.00	°C/W

^{1.} When mounted on 1 inch² FR-4 board, 2 oz. Cu., $t \le 10$ sec

Note: For the P-channel MOSFET actual polarity of voltages and current has to be reversed

^{2.} This value is rated according to $R_{\mbox{\scriptsize thj-pcb}}$

^{3.} Pulse width is limited by safe operating area

Electrical characteristics STL40C30H3LL

2 Electrical characteristics

Table 4. On/off states

Symbol	Parameter	Test conditions	Channel	Min.	Тур.	Max.	Unit
V	Drain-source	L = 250 uA V = = 0	N	30			V
V _{(BR)DSS}	breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	Р	30			V
		V = 20 V	N			1	Δ
l- aa	Zero gate voltage	V _{DS} = 30 V	Р			'	μΑ
DSS	drain current (V _{GS} = 0)	N			10	Δ	
		V _{DS} =30 V, T _C =125 °C	Р			10	μΑ
1	Gate-body leakage	V _{GS} = ±20 V	N			±100	nA
I _{GSS}	current (V _{DS} = 0)	V _{GS} - ±20 V	Р			±100	ПА
V	Gate threshold voltage	V V - 1 - 250 uA	N	1			V
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	Р	•			V
		V 10 V I - 4 A	N		0.019	0.021	Ω
R _{DS(on)}	Static drain-source	$V_{GS} = 10 \text{ V}, I_{D} = 4 \text{ A}$	Р		0.024	0.03	Ω
	on-resistance	V = 45 V I = 4 A	N		0.023	0.028	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$	Р		0.038	0.05	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Channel	Min.	Тур.	Max.	Unit
C	C _{iss} Input capacitance		N	-	475	-	pF
C _{iss}		V _{DS} = 24 V, f = 1 MHz,	Р	-	1450	-	pF
	Output canacitance		N	-	97	-	pF
C _{oss}	S Output capacitance	$V_{GS} = 0$	Р	-	178	-	pF
(Reverse transfer		N	-	19	-	pF
C_{rss}	capacitance		Р	-	120	-	pF
0	Total gate charge		N	-	4.6	-	nC
Q_g	Total gate charge		Р	-	12	-	nC
0	Gata source charge	V _{DD} =24 V I _D =8 A	N	-	1.7	-	nC
Q gs	Q _{gs} Gate-source charge	V _{GS} = 4.5 V (see Figure 25)	Р	-	4.4	-	nC
Q _{gd} Ga	Gata drain abarga	, ,	N	-	1.9	-	nC
	Gate-drain charge		Р	-	5	-	nC

Note: For the P-channel MOSFET actual polarity of voltages and current has to be reversed

Table 6. Switching times

Symbol	Parameter	Test conditions	Channel	Min.	Тур.	Max.	Unit
+	Turn-on delay time		N	-	4	-	ns
^L d(on)	t _{d(on)} I urn-on delay time		Р	-	15	-	ns
+	Rise time		N	-	22	-	ns
L _r	t _r Rise time	$V_{DD} = 24 \text{ V}, I_{D} = 4 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$	Р	-	15	-	ns
	t _{d(off)} Turn-off delay time	Figure 24	N	-	13	-	ns
^L d(off)			Р	-	24	-	ns
t₄ Fall time		N	-	2.8	-	ns	
t _f	raii iiiile		Р	-	21	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Channel	Min.	Тур.	Max.	Unit
	Source-drain current		N	-		10	Α
I _{SD}	Source-drain current		Р	1		8	Α
I _{SDM} ⁽¹⁾	Source-drain current		N	-		40	Α
'SDM `	(pulsed)		Р	-		32	Α
V (2)	$V_{SD}^{(2)}$ Forward on voltage $I_{SD} = 8A, V_{GS} =$	tage I _{SD} = 8A, V _{GS} = 0	N	1		1.1	V
VSD \			Р	-		1.1	٧
	Reverse recovery time		N	-	16.2		ns
t _{rr}	neverse recovery time		Р	1	15		ns
0	Reverse recovery	$I_{SD} = 8 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 16 \text{ V, T}_i = 150 ^{\circ}\text{C}$	N	-	8.1		nC
Q _{rr}	charge	Figure 26	Р	-	6.5		nC
1	Reverse recovery		N	-	1		Α
IRRM	current		Р	-	0.9		Α

^{1.} Pulse width limited by safe operating area.

Note: For the P-channel MOSFET actual polarity of voltages and current has to be reversed

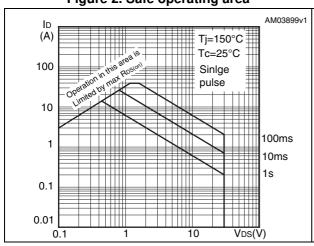
^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STL40C30H3LL

2.1 Electrical characteristics (curves) for N-channel

Figure 2. Safe operating area

Figure 3. Thermal impedance



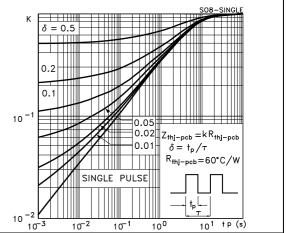
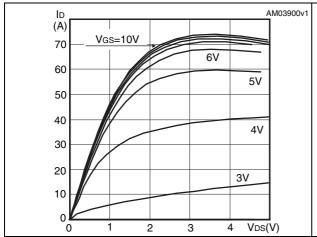


Figure 4. Output characteristics

Figure 5. Transfer characteristics



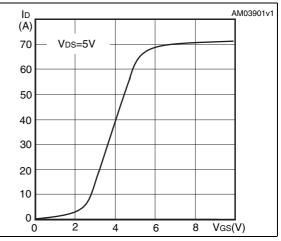
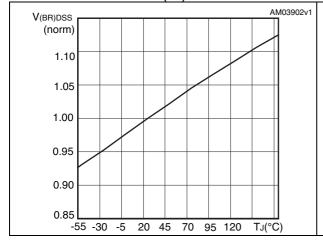
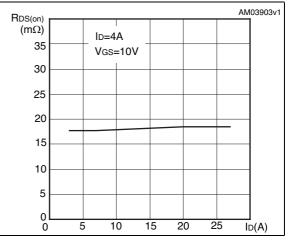


Figure 6. Normalized $V_{(BR)DSS}$ vs temperature

Figure 7. Static drain-source on-resistance





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Figure 8. Gate charge vs gate-source voltage

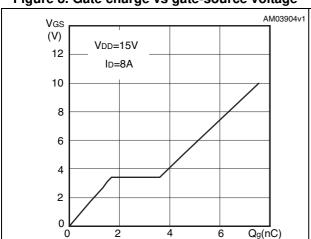


Figure 9. Capacitance variations

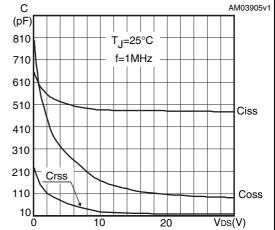
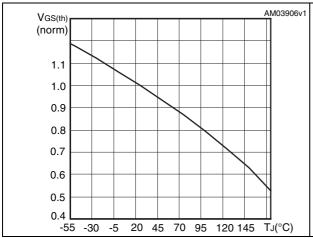


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



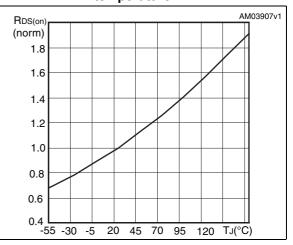
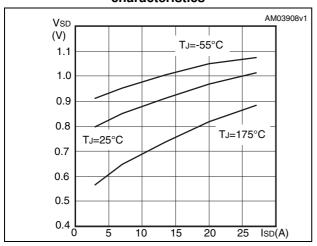


Figure 12. Source-drain diode forward characteristics

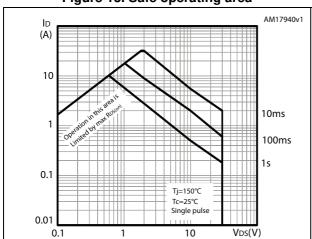


Electrical characteristics STL40C30H3LL

2.2 Electrical characteristics (curves) for P-channel

Figure 13. Safe operating area

Figure 14. Thermal impedance



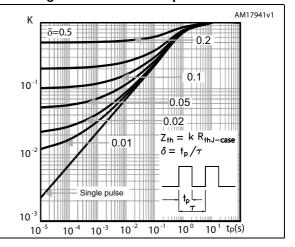
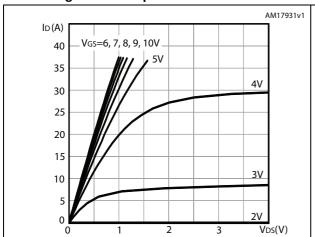


Figure 15. Output characteristics

Figure 16. Transfer characteristics



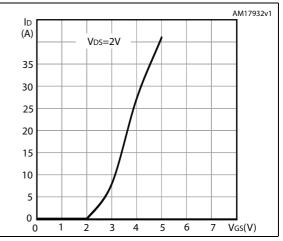
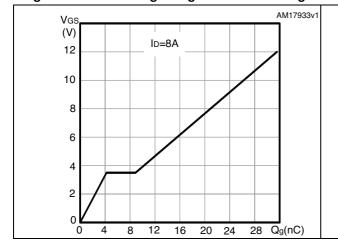
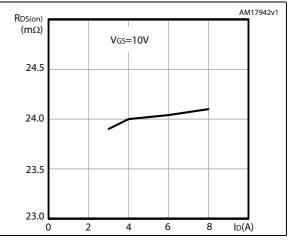


Figure 17. Gate charge vs gate-source voltage

Figure 18. Static drain-source on-resistance

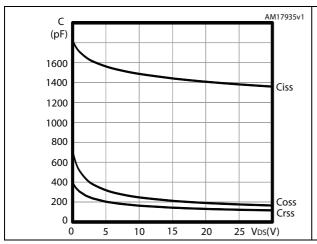




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Figure 19. Capacitance variations

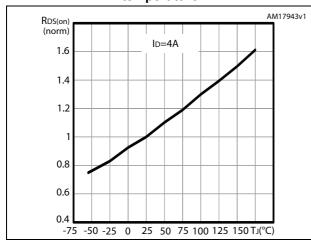
Figure 20. Normalized gate threshold voltage vs temperature



VGS(th) (norm) | ID=250μA | ID=2

Figure 21. Normalized on-resistance vs temperature

Figure 22. Normalized $\rm V_{(BR)DSS}$ vs temperature



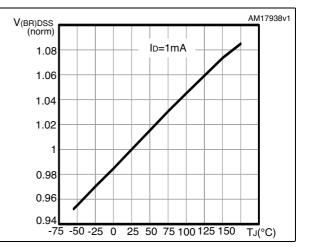
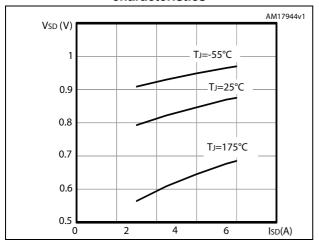


Figure 23. Source-drain diode forward characteristics



3 Test circuits for N-channel

Figure 24. Switching times test circuit for resistive load

Figure 25. Gate charge test circuit

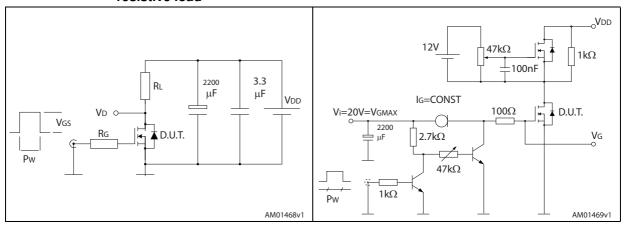


Figure 26. Test circuit for inductive load switching and diode recovery times

Figure 27. Unclamped inductive load test circuit

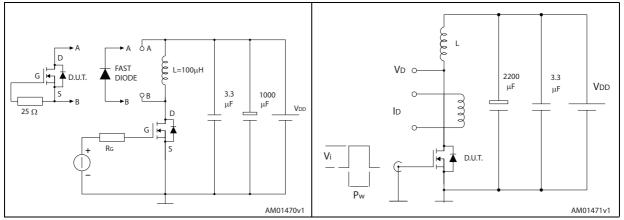
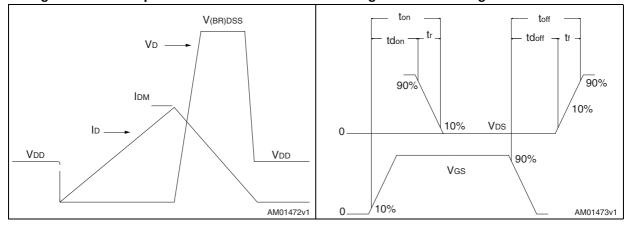


Figure 28. Unclamped inductive waveform

Figure 29. Switching time waveform



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4 Test circuits for P-channel

Figure 30. Switching times test circuit for resistive load

Figure 31. Gate charge test circuit

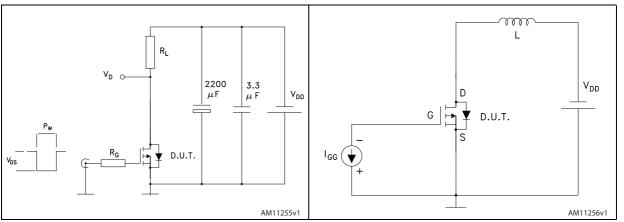
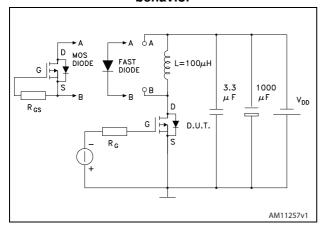


Figure 32. Test circuit for diode recovery behavior



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5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



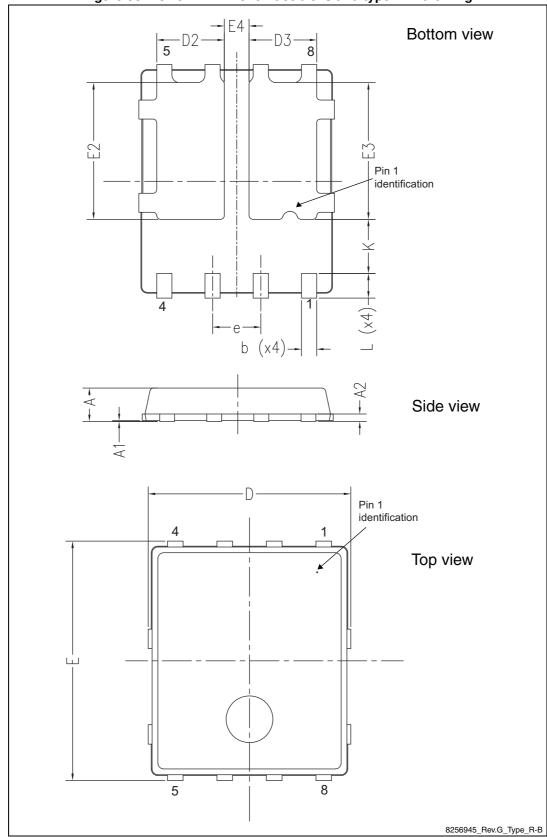


Figure 33. PowerFLAT™ 5x6 - double island type R-B drawing

Table 8. PowerFLAT™ 5x6 - double island type R-B mechanical data

Def		Dimensions (mm)					
Ref.	Min.	Тур.	Max.				
А	0.80		1.00				
A1	0.02		0.05				
A2		0.25					
b	0.30		0.50				
D	5.00	5.20	5.40				
E	5.95	6.15	6.35				
D2	1.68		1.88				
E2	3.50		3.70				
D3	1.68		1.88				
E3	3.50		3.70				
E4	0.55		0.75				
е		1.27					
L	0.60		0.80				
K	1.275		1.575				

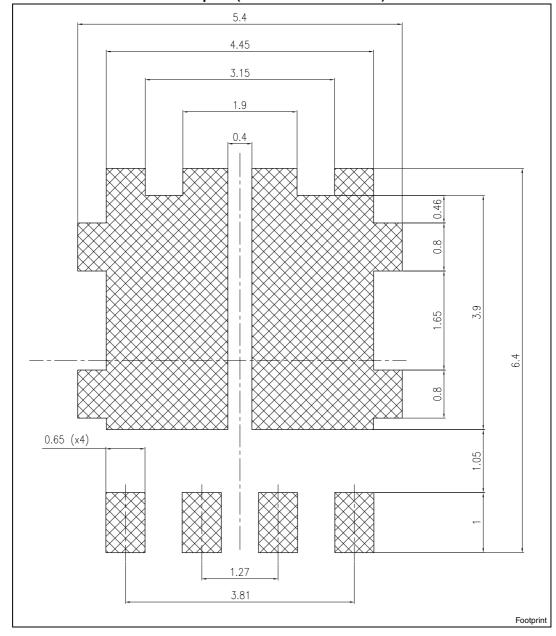


Figure 34. PowerFLAT™ 5x6 - double island type R-B drawing recommended footprint (dimensions are in mm)



6 Packaging mechanical data

Figure 35. PowerFLAT™ 5x6 tape^(a)

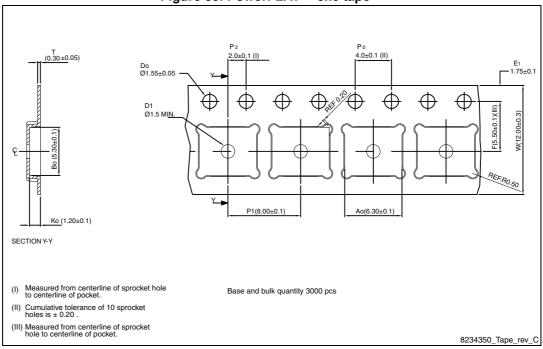
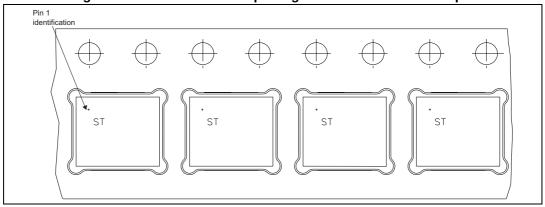


Figure 36. PowerFLAT™ 5x6 package orientation in carrier tape.



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a. All dimensions are in millimeters.

Figure 37. PowerFLAT™ 5x6 reel



Revision history STL40C30H3LL

7 Revision history

Table 9. Revision history

Date	Revision	Changes
31-Oct-2012	1	First revision.
09-Nov-2012	2	 Modified: R_{DS(on)} values for N-channel Changed: Section 5 on page 12
13-Feb-2013	3	 Modified: R_{DS(on)} only for P-channel on the title, <i>Features</i> table and <i>Table 4</i> Modified: typical values on <i>Table 5</i>, <i>28</i>, <i>29</i>, V_{SD} max value on <i>Table 29</i> (only for P-channel) Updated: <i>Section 5: Package mechanical data</i> and <i>Section 6: Packaging mechanical data</i>
28-Nov-2013	4	 Modified: V_{GS} (for P-channel) value in <i>Table 2</i> Modified: I_{GSS} (test conditions values) Modified: Q_g typical values Modified: <i>Figure 24, 25, 26, 27, 28, 29, 30</i> and <i>31</i> Updated: <i>Section 5: Package mechanical data</i> Minor text changes
03-Apr-2014	5	 Added: Section 2.1: Electrical characteristics (curves) for N-channel Minor text changes

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